

# THROUGH-HOLE MICRO SOCKET

(1.27 mm) .050" PITCH • SLM/SMS SERIES



#### SLM

### Mates:

HTMS, TMS, MTMS, DWM, HDWM, FTR, HMTMS

## **SMS**

#### Mates:

HTMS, TMS, MTMS, DWM, HDWM, FTR, TML, ZML, HMTM

#### **SPECIFICATIONS**

#### Insulator Material:

SLM: Black Glass Filled Polyester SMS: Black LCP

#### Contact Material:

# Phosphor Bronze Plating: Au or Sn over 50 μ" (1.27 μm) Ni Current Rating (SLM/TMS): 5 2 Δ per pin

5.2 A per pin (2 pins powered) Current Rating (SMS/TMS):

## 5.0 A per pin

# 5.0 A per pin (2 pins powered) Operating Temp Range: -55 °C to +125 °C with Gold -55 °C to +105 °C with Tin

Insertion Depth:

INSERTION Depth: SLM: (2.03 mm) .080" to (3.05 mm) .120" SMS: (3.43 mm) .135" to (6.35 mm) .250" with (0.38 mm) .015" wipe

#### **PROCESSING**

#### Lead-Free Solderable:

SLM: No, Lead Wave Only SMS: Yes

#### **ALSO AVAILABLE**

Other Platings (MOQ Required)





### NO. PINS PER ROW



#### **PLATING OPTION**



**ROW** 

OPTION

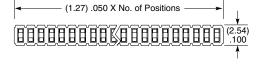
01 thru 50

= 10  $\mu$ " (0.25  $\mu$ m) Gold on contact, Matte Tin on tail

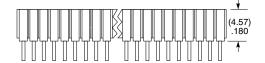
Single Row

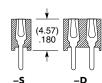
-G = 20  $\mu$ " (0.51  $\mu$ m) Gold on contact, Gold flash on balance











## **SMS**



# NO. PINS PER ROW

# LEAD STYLE

## PLATING OPTION

#### **ROW** OPTION

#### 01 thru 50

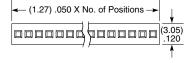
#### Specify LEAD **STYLE** from chart

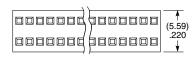
= 10  $\mu$ " (0.25  $\mu$ m) Gold on contact, Matte Tin on tail

-S = Single Row

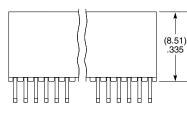
= 20 μ" (0.51 μm) Gold on contact, Gold flash on balance

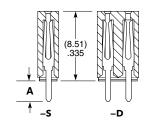
-D = Double Row





LEAD STYLE	A
-01	(2.54) .100
-02	(4.83) .190





#### Note:

Some lengths, styles and options are non-standard, non-returnable.